Docket No.: MUH-12818

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant

**IOANNIS DOTSIKAS** 

Filed

CONCURRENTLY HEREWITH

Title

METHOD AND FURNACE FOR THE VAPOR PHASE

DEPOSITION OF COMPONENTS ONTO SEMICONDUCTOR SUBSTRATES WITH A VARIABLE MAIN FLOW DIRECTION OF

THE PROCESS GAS

## INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In accordance with 37 C.F.R. 1.98 copies of the following patents and/or publications are submitted herewith:

U.S. Patent No. 5,484,484 (Yamaga et al.), dated January 16, 1996;

U.S. Patent No. 6,045,617 (Keller), dated April 4, 2000 and corresponding German Patent DE 197 43 922 C1 (Keller), dated April 15, 1999;

Patent Abstracts of Japan 63065080 A (Katsuyoshi et al.), dated March 23, 1988.

Respectfully submitted,

Date: September 30, 2003

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FORM PTO-1449 (SUBSTITUTE)  U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE				Attorney Docket No.: MUH-12818 Appl. No.:				
INFORMATION DISCLOSURE STATEMENT BY APPLICANT				Applicant: IOANNIS DOTSIKAS				
(37 CFR 1.98(b))				Filing Date: September 30, 2003 Group Art Unit:				
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EXAMINER INITIALS		PATENT NO.	DATE	PATENTEE	CLASS	SUB CLASS		ING TE
	Α	5,484,484	1/16/96	Yamaga et al.				
	В	6,045,617	4/4/00	Keller				
	С							
	D							
	E							
	F							
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FOREIGN PATENT DOCUMENT								
		DOCUMENT NO.	DATE	COUNTRY	CLASS	SUB CLASS	TRAI YES	
	J	197 43 922 C1	4/15/99	Germany	OLAGO	OLAGO	123	110
**************************************	K	63065080 A	3/23/88	Japan				
	L							
	М							
	N							
OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)								
		-		-		,		
EXAMINER				DATE CONSIDERED				
EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.								